

HF & NFC Inlay

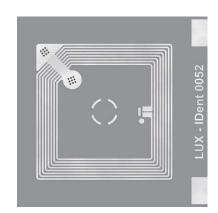
25 × 25 mm

(AI)



Product code:

L15-025025C11-xxx (50 pF)





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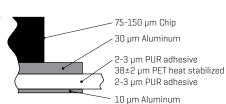
A range of applications.

LUX-IDent smart inlays are ultra-thin, flexible and designed to be combined with the ideal RFID chip type to attain highest possible performance level at minimum cost.

INLAY OVERVIEW WITH DIMENSIONS - IN REEL FORMAT (mm)

Unwinding direction Marking of defect inlay 3 35±0.1 [MD] D.5±0.5 Direction Marking of defect inlay 3 35±0.1 [MD] D.5±0.5 Direction Marking of defect inlay 3 35±0.1 [MD] D.5±0.5 Direction Marking of defect inlay 3 35±0.1 [MD] D.5±0.5 Direction Directi

CROSS SECTION



The chip position in MD direction can vary depending on the inlay tuning frequency and chip size (type).

The inlays are ready for converting into various types of smart labels / tickets / tags as typically used for RFID applications in:

- Logistics
- Asset management
- Supply chain management
- Transportation
- Identification and authentication
- NFC

RFID CHIP TYPES

Manufacturer Standard	Chip type	
NXP		
ISO 15693 ISO 18000 3M3		
ISO 14443A	MIFARE Ultralight® Family	
NFC	NTAG™210µ, NTAG™213/215/216	
Infineon		
ISO 15693		
ISO 14443A		
NFC		
STMicroelectronics		
ISO 15693		
ISO 14443A	ST25TA512, ST25TA02K	
NFC	ST25TA512, ST25TA02K	
EM Microelectroni	С	
ISO 15693		
NFC	EM4423 (HF)	
Fujitsu		
ISO 15693		

Other ICs are available upon request.

RELIABILITY

Operation temperature	-25°C to 70°C/85°C, depending on chip specification
Storage conditions	1 year at 10°C to 25°C, maximum 60% relative humidity
Thermal humidity test	168h at 85°C / 85% humidity
Temperature cycle resistance	250 cycles at -40°C to 85°C
Bending	Chip upside: Ø 30mm – 15N 35mm (CD) 30N 48mm (CD) Chip downside: Ø 40mm – 15N 35mm (CD) 30N 48mm (CD)
Shear force onto chip	10N / mm² chip area
ESD voltage immunity	±2kV max. peak – human body model (HBM) accord. to chip specification

INLAY DELIVERY DETAILS

Quantity on reel	5,000 / 10,000
Reel dimension	Ø Reel: 265 mm / 365 mm Ø Core: 76.2 mm (3")
QC inspection inline	100% electrical UID test with bad marking of rejected inlays

LUX-IDent products are not designed, intended, authorized or warranted to be suitable for life support applications or any other life critical applications which could involve potential risk of death, personal injury or severe property or environmental damage.

LUX-IDent assumes neither liability nor responsibility for the technical performance and specifications of the RFID chip type used in the transponder inlay.

Link to chip specification: http://www.lux-ident.com/chip-technologies

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